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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/726,326	12/02/2003	Haining S. Yang	FIS920030318US1	3668
7590 08/24/2004				
Frederick W. Gibb, III McGinn & Gibb, PLLC Suite 304 2568-A Riva Road Annapolis, MD 21401			EXAMINER VU, HUNG K	
			ART UNIT 2811	PAPER NUMBER
DATE MAILED: 08/24/2004				

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/726,326

Applicant(s)

YANG, HAINING S.

Examiner

Hung K. Vu

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 05 August 2004.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-28 is/are pending in the application.
- 4a) Of the above claim(s) 15-28 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-14 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413) |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____ |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| Paper No(s)/Mail Date <u>12/2/03</u> . | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Election/Restrictions

1. Applicant's election without traverse of Invention of Group I, Claims 1-14, in the reply filed on 08/05/04 is acknowledged.

Claims 15-28 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected Invention, there being no allowable generic or linking claim.

Election was made **without** traverse in the reply filed on 08/05/04.

Claim Objections

2. Claims 1 and 8 are objected to because of the following informalities: In claim 1, line 2, and claim 8, line 3, "the same substrate" should be changed to "a same substrate" for clarity. Appropriate correction is required.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1, 6-8 and 13-14 are rejected under 35 U.S.C. 102(b) as being anticipated by Dawson et al. (PN 5,963,803, of record).

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Dawson et al. discloses, as shown in Figure 1L, an integrated circuit structure comprising:

first-type transistors and second-type transistors formed on a same substrate (102),

wherein the first-type transistors and the second-type transistors comprise:

gate conductors (122,126) over channel regions in the substrate;

sidewall spacers (146,144) adjacent the gate conductors;

source and drain extensions (140,142,130,132) on opposite sides of the channel

regions,

wherein sidewall spacers are larger in the first-type transistors (146) than in the second-type transistors (144).

With regard to claims 6 and 13, Dawson et al. discloses the first-type transistors (PMOS) have different performance characteristics than the second-type transistors (NMOS).

With regard to claims 7 and 14, Dawson et al. discloses the source and drain extensions in the first-type transistors (boron) are made of a different material than in the second-type transistors (phosphorus).

With regard to claim 8, Dawson et al. discloses an integrated circuit structure comprising:

P-type field effect transistors (PFETs) and N-type field effect transistors (NFETs) formed on a same substrate (102),

wherein PFETs and NFETs comprise:

gate conductors (122,126) over channel regions in the substrate;

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sideall spacers (146,144) adjacent the gate conductors

source and drain extensions (140,142,130,132) on opposite sides of the channel

regions,

wherein sidewall spacers are larger in PFETs (146) than in NFETs (144).

4. Claims 1-2, 4-9 and 11-14 are rejected under 35 U.S.C. 102(e) as being anticipated by Hellig et al. (PN 6,696,334).

Hellig et al. discloses, as shown in Figures 2-12, an integrated circuit structure comprising:

first-type transistors (210,310) and second-type transistors (215,315) formed on a same substrate (230),

wherein the first-type transistors and the second-type transistors comprise:

gate conductors (218,225,319,325) over channel regions in the substrate;

sidewall spacers (219,223,831,837) adjacent the gate conductors;

source and drain extensions (217,222,not shown) on opposite sides of the channel

regions,

wherein sidewall spacers are larger in the first-type transistors than in the second-type transistors.

With regard to claims 2 and 9, Hellig et al. discloses the source and drain extensions are spaced further from the channel regions in the first-type transistors than in the second-type transistors.

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With regard to claims 4 and 11, Hellig et al. discloses the sidewall spacers include oxide liners, and wherein the oxide liners are thicker in the first-type transistors than in the second-type transistors.

With regard to claims 5 and 12, Hellig et al. discloses sidewall spacers comprise multiple-layer sidewall spacers, and sidewall spacers in the first-type transistors have more sidewall spacer layers than in the second-type transistors [Figure 12].

With regard to claims 6 and 13, Hellig et al. discloses the first-type transistors (PMOS) have different performance characteristics than the second-type transistors (NMOS).

With regard to claims 7 and 14, Hellig et al. discloses the source and drain extensions in the first-type transistors (boron) are made of a different material than in the second-type transistors (phosphorus).

With regard to claim 8, Hellig et al. discloses, as shown in Figures 2-12, an integrated circuit structure comprising:

P-type field effect transistors (PFETs, 210, 310) and N-type field effect transistors (NFETs, 215, 315) formed on a same substrate (230),

wherein PFETs and NFETs comprise:

gate conductors (218, 225, 319, 325) over channel regions in the substrate;

sidewall spacers (219, 223, 831, 837) adjacent the gate conductors

source and drain extensions (217,222,not shown) on opposite sides of the channel regions,

wherein sidewall spacers are larger in PFETs than in NFETs.

Claim Rejections - 35 USC § 103

5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 3 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Dawson et al. (PN 5,963,803, of record) in view of Sakurai et al. (US 2001/0052648).

Dawson et al. discloses the claimed invention including an integrated circuit structure as recited in the rejection above. Dawson et al. does not disclose the structure further comprising silicide regions between portions of the sidewall spacers and the substrate, wherein the silicide regions are larger in the first-type transistors than in the second-type transistors. However, Sakurai et al. discloses a structure comprising silicide regions (7b&107b,7b) between portions of sidewall spacers (9) and a substrate (1), wherein the silicide regions are larger in the first-type transistors than in the second-type transistors. Note Figure 16 of Sakurai et al.. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to form the structure of Dawson et al. having silicide regions between portions of the sidewall spacers and the substrate, wherein the silicide regions are larger in the first-type transistors than in the second-type transistors, such as taught by Sakurai et al. in order to suppress occurrence of the

junction leak so that an off-leak current of the transistor can be suppressed and the power consumption can be reduced.

6. Claims 3 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hellig et al. (PN 6,696,334) in view of Sakurai et al. (US 2001/0052648).

Hellig et al. discloses the claimed invention including an integrated circuit structure as recited in the rejection above. Hellig et al. does not disclose the structure further comprising silicide regions between portions of the sidewall spacers and the substrate, wherein the silicide regions are larger in the first-type transistors than in the second-type transistors. However, Sakurai et al. discloses a structure comprising silicide regions (7b&107b,7b) between portions of sidewall spacers (9) and a substrate (1), wherein the silicide regions are larger in the first-type transistors than in the second-type transistors. Note Figure 16 of Sakurai et al.. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to form the structure of Hellig et al. having silicide regions between portions of the sidewall spacers and the substrate, wherein the silicide regions are larger in the first-type transistors than in the second-type transistors, such as taught by Sakurai et al. in order to suppress occurrence of the junction leak so that an off-leak current of the transistor can be suppressed and the power consumption can be reduced.

Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hung K. Vu whose telephone number is (571) 272-1666. The

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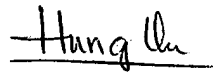
examiner can normally be reached on Mon-Thurs 6:00-3:30, alternate Friday 7:00-3:30, Eastern Time.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C. Lee can be reached on (571) 272-1732. The Central Fax Number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

Vu

August 20, 2004

A handwritten signature in black ink, appearing to read "Hung Vu", is written over a horizontal line.

Hung Vu

Patent Examiner